



P-Channel Enhancement Mode Field Effect Transistor

Description

The ACE4441B uses advanced trench technology to provide excellent $R_{DS(ON)}$, and ultra-low low gate charge. This device is suitable for use as a load switch or in PWM applications.

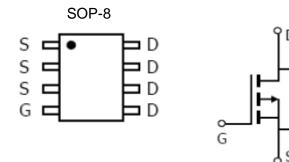
Features

- V_{DS}(V)=-60V
- I_D=-4A (V_{GS}=-10V)
- $R_{DS(ON)}$ < 75m Ω (V_{GS} =-10V)
- $R_{DS(ON)} < 90 \text{m}\Omega \text{ (V}_{GS} = -4.5 \text{V)}$

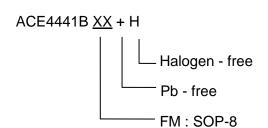
Absolute Maximum Ratings

Absolute maximum Rutings									
Parameter		Symbol	Max	Unit					
Drain-Source Voltage		V_{DS}	-60	V					
Gate-Source Voltage			±20	V					
Drain Current (Continuous) * AC	T _A =25°C	1	-4	Α					
	T _A =70°C	l _D	-3.2						
Drain Current (Pulse) * B		I _{DM}	-20						
Power Dissipation	T _A =25°C	P _D	3	W					
	T _A =70°C	T D	2.1	VV					
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to 150	°С					

Packaging Type



Ordering information





ACE4441B

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Electrical Characteristics

T_A=25 °C unless otherwise noted

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit			
Static									
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250uA	-60			V			
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =-48V, V_{GS} =0V			-1	uA			
Gate Leakage Current	I _{GSS}	$V_{GS}=\pm20V$, $V_{DS}=0V$			100	nA			
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-4.5A		64	75	mΩ			
		V_{GS} =-4.5V, I_{D} =-3.5A		79	90				
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{DS}=-250\mu A$	-1.0	-1.7	-2.5	V			
Forward Transconductance	g FS	V _{GS} =-10V, I _D =-7A		9		S			
Diode Forward Voltage	V _{SD}	I _{SD} =-1A, V _{GS} =0V		-0.76	-1	V			
Maximum Body-Diode Continuous Current	Is				-3	А			
	S	Switching							
Total Gate Charge	Q_g	V_{DS} =-30V, I_{D} =-7A V_{GS} =-10V		15	19	nC			
Gate-Source Charge	Q_{gs}			2.5					
Gate-Drain Charge	Q_{gd}			3					
Turn-On Delay Time	$T_{d(on)}$	V_{DS} =-30V, R_{L} =10 Ω , V_{GS} =-10V, R_{GEN} =3 Ω		8	16	ns			
Turn-On Rise Time	t _f			3.8	7.6				
Turn-Off Delay Time	$t_{d(off)}$			31.5	63				
Turn-Off Fall Time	t _f			7.5	15				
		Dynamic							
Input Capacitance	C _{iss}	V _{DS} =-30V, V _{GS} =0V f=1MHz		760		pF			
Output Capacitance	C _{oss}			90					
Reverse Transfer Capacitance	C _{rss}			40					

Note: 1. The value of R θ_{JA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design.

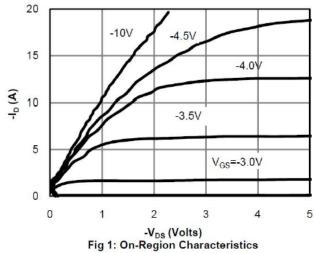
- 2. Repetitive rating, pulse width limited by junction temperature.
- 3. The current rating is based on the t≤ 10s junction to ambient thermal resistance rating.

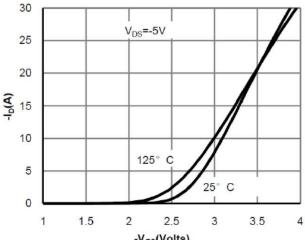




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Typical Performance Characteristics





-V_{GS}(Volts)
Figure 2: Transfer Characteristics

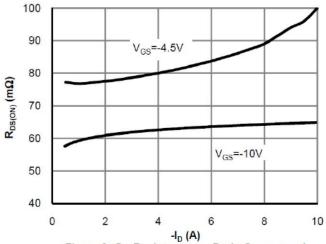


Figure 3: On-Resistance vs. Drain Current and **Gate Voltage**

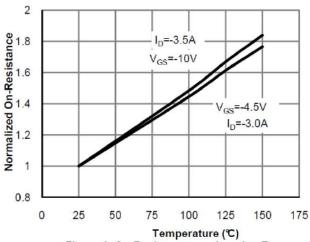


Figure 4: On-Resistance vs. Junction Temperature

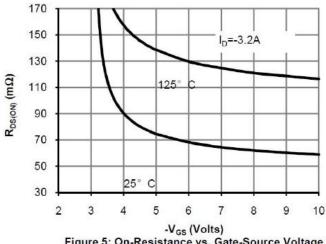
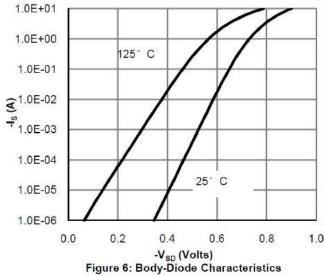


Figure 5: On-Resistance vs. Gate-Source Voltage



3





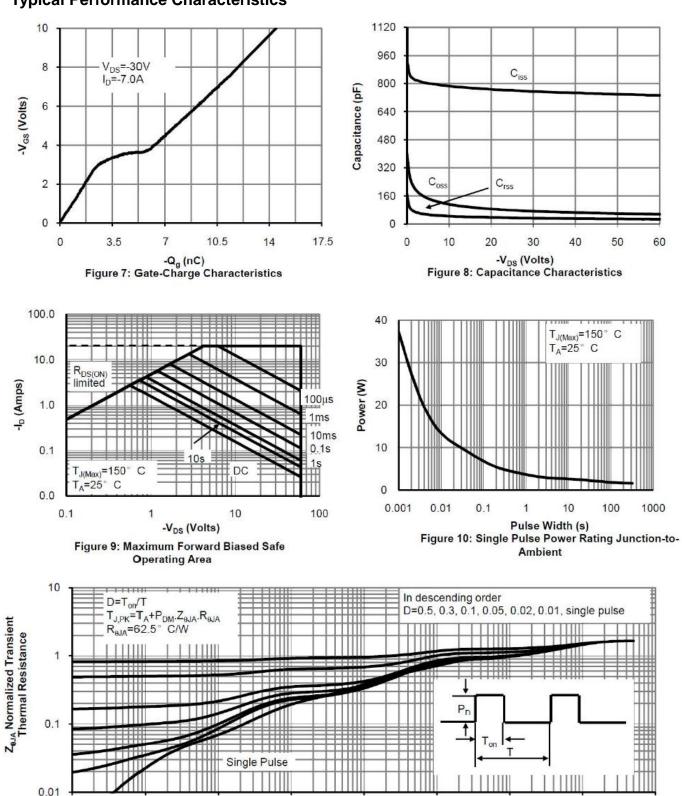
0.00001

0.0001

0.001

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Typical Performance Characteristics



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance

0.1

1

10

100

0.01

1000

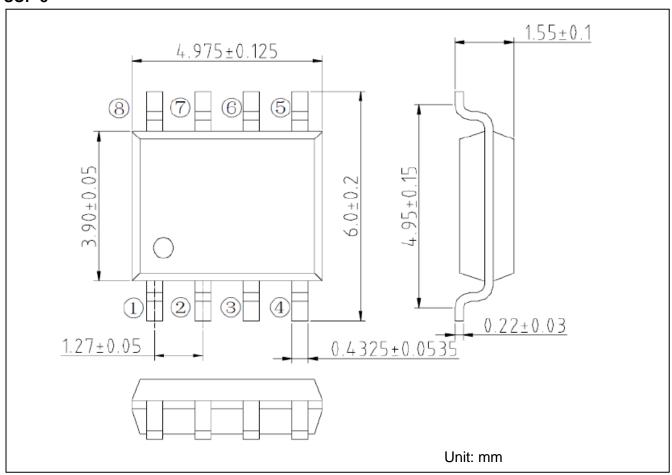




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Packing Information

SOP-8





ACE4441B

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Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and shoes failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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